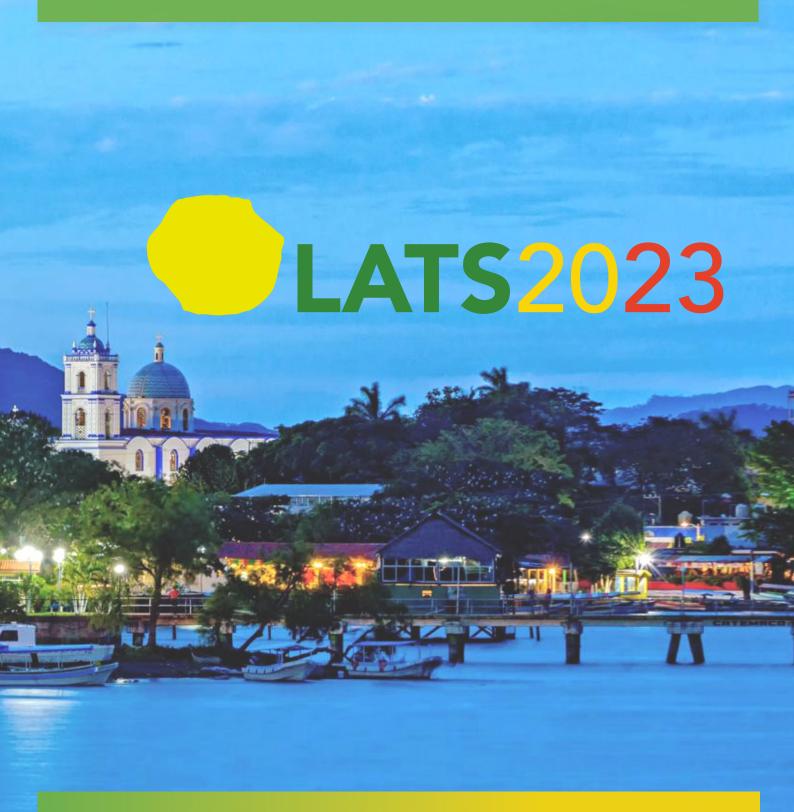
PRELIMINARY CALL FOR PAPERS



24th IEEE Latin-American Test Symposium

Veracruz, Mexico, 21st - 24th March 2023

24th IEEE Latin-American Test Symposium

Veracruz, Mexico, 21st - 24th March 2023



CALL FOR PAPERS

The IEEE Latin-American Test Symposium (LATS) is a recognized forum dedicated to presenting and discussing scientific results, emerging ideas, applications, hot topics and new trends in the area of electronic-based circuits and system testing, reliability, and security. LATS is attended by professionals from all over the world, in particular from Latin-America. Accepted papers will be submitted for inclusion into IEEE Xplore subject to meeting IEEE Xplore's scope and quality requirements and the best papers of its $24^{\rm th}$ edition will be invited to re-submit to IEEE Design&Test, Journal of Electronic Testing: Theory and Applications (JETTA - Springer), and IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD).

Topics of interest include, but are not limited to

- Analog Mixed Signal Test
- Automatic Test Generation
- Built-In Self-Test
- Defect-Based Test
- Design and Synthesis for Testability
- Design for Electromagnetic Compatibility
- Design for Reliable Embedded Software
- Design Verification / Validation
- Fconomics of Test
- Fault Analysis and Diagnosis
- Fault Modeling and Simulation

- Fault-Tolerance in HW/SW
- Fault-Tolerant Architectures
- Memory Test and Repair
- On-Line Testing
- Radiation / Electromagnetic Interference
- Hardening Techniques
- Software Fault-Tolerance
- System-on-Chip Test
- Test Resource Partitioning
- Yield Optimization
- Hardware Security

Paper Submission Information

To encourage and facilitate discussions, participation will be limited. Those interested in presenting recent results at the symposium are invited to submit an extended abstract (one to three pages) or a full paper (six pages). PDF electronic submissions must be done via the symposium's webpage: www.lats.tttc-events.org

Authors should send papers in the IEEE conference format. Detailed instructions are available at the symposium's webpage. The Program Committee also welcomes proposals for panels and special sessions.

For additional information, please contact our Program Co-Chairs:

Leticia Bolzani Poehls – RWTH Aachen, Germany – leticia@poehls.com Ernesto Sanchez - Politecnico di Torino, Italy - ernesto.sanchez@polito.it

Submission Deadline (Title and Abstract): Dezember 23rd, 2022

Submission Deadline (Full Paper): January 10th, 2023

Notification of Acceptance: January 31st, 2023

Camera Ready: February 7th, 2023.

The harbor of Veracruz is a city founded in 1519 and located in the Mexican Gulf. It is easily reachable by road and plains. Veracruz is well known for its cultural diversity and the people's hospitality. The state of Veracruz offers wide biodiversity, beautiful beaches, riffs and a subtropical forest. Music is vital in the life of local people (known as "jarochos"). In their traditional music rhythms, we can find danzon, son, salsa, and marimba, among others. Veracruz is also known for having delicious cuisine. This results from fresh ingredients and cooking techniques based on the mixture of pre-Hispanic, European and African cultures. Besides, Veracruz is also a modern city with all the facilities for a pleasant stay.

Main Organizing Institution:



Astrophysics, Optics and Electronics - INAOE

Financial Sponsors:





Astrophysics, Optics and Electronics - INAOE

Co-organizing Institutions:



University of Sonora

Technical Sponsors:



Electrical and Electronics

Test Technology
Technical Council

Steering Committee:

Victor Champac – INAOE, Mexico Marcelo Lubazewski – UFRGS, Brazil Fabian Vargas – IHP GmbH, Germany Raoul Velazco – TIMA, France

Yervant Zorian – Synopsys, USA Tiago Balen – UFRGS, Brazil Leticia M. Bolzani Pöhls – RWTH Aachen, Germany Matteo Sonza Reorda – Politecnico di Torino, Italy

General Chairs

Victor Champac – INAOE, Mexico Yervant Zorian – Synopsys, USA

Past General Co-Chairs

Raoul Velazco – TIMA, France Yervant Zorian – Synopsys, USA

Program Co-Chairs

Leticia Bolzani Poehls – RWTH Aachen, Germany Ernesto Sanchez – Politecnico di Torino, Italy

Jaime Martinez – U. Veracruzana, Mexico

Publication Chair Tiago Balen – UFRGS, Brazil

Publicity Chair

Elena Ioana Vatajelu – TIMA, France

Embedded Tutorial Chair

Special Session Chair

atteo Sonza Reorda – Politecnico di Torino, Italy

Panel Chairs

abian Vargas – IHP GmbH, Germany

Web Chair

Roberto Gomez - University of Sonora, Mexico

Industry Liaison

Hector Villacorta – Semtech, Mexico Magdy Abadir – USA

European LiaisonsMaksim Jenihhin – Tallinn U. of Tech., Estonia
Graziano Pravadelli – University of Verona, Italy

LA Liaisons Eduardo Bezerra – UFSC, Brazil Felipe Restrepo – Nat. U. of Colombia, Colombia

Technical Committee

Adit Singh - Auburn University, USA
Alex Orailoglu - University of California, USA
Annachiara Ruospo - Politecnico di Torino, Italy
Antonio Miele - Politecnico di Milano, Italy
Artur Jutman - Testonica, Estonia
Carlos Cardenas - PUCP, Peru
Celia Lopez - UCM3, Spain
Cristina Meinhardt - UFSC, Brazil
Daniel Tille - Infineon, Germany
Davide Appello - ST Microelectronics, Italy
Dimitris Gizopoulos - University of Athens, Greece
Elena-loana Vatajelu - TIMA Lab, France
Erik Larsson - Lund University, Sweden
Fabian Vargas - IHP, Germany
Felipe Restrepo - Nat. Univ. of Colombia, Colombia
Florence Azais - LIRMM, France
Frank Sill - DLR, Germany Adit Singh - Auburn University, USA

Florence Azais - LIRMM, France Frank Sill - DLR, Germany Goerschwin Fey - TUHH, Germany Gurgen Harutyunyan - Synopsys, Armenia Hans Wunderlich - University of Stuttgart, Germany Haralampos Stratigopoulos - Sciences Sorbonne Université, France

Université, France
Haruo Kobayashi - Gunma, Japan
Ilia Polian - University of Stuttgart, Germany
Julio Perez - UDELAR, Uruguay
Lorena Anghel - TIMA Lab, France
Luigi Diililo - LIRMM, France
Maksim Jenihhin - Tallinn Univ. of Tech., Estonia
Marcello Traiola - INRIA, France
Mario Schötzel - Hochschule Nordhausen, Germany
Massima Viklanta - Rittergino di Torino Litaly

Mario Schötzel - Hochschule Nordhausen, Germany Massimo Violante - Politecnico di Torino, Italy Matteo Sonza Reorda - Politecnico di Torino, Italy Michele Portolan - Univ. Grenoble Alpes, France Mihalis Psarakis - University of Piraeus, Greece Mottaqiallah Taouil - TU Delft, The Netherlands Mounir Bernabdenbi - Univ. Grenoble Alpes, France Nicola Nicolici - McMaster University, Canada Paolo Bernardi - Politecnico di Torino, Italy Patrick Girard - LIRMM, France Paulo Butzen - UFRGS, Brazil Regis Levugle - TIMA Lab. France

Regis Leveugle - TIMA Lab, France
Riccardo Cantoro -Politecnico di Torino, Italy
Riccardo Mariani - NVIDIA, Germany
Rodrigo Bastos - Université Grenoble Alpes, France
Rolf Drechsler - Université Grenoble Alpes, France
Salvador Mir - Université Grenoble Alpes, France

Stefano Di Carlo - Politecnico di Torino, Italy Sybille Hellebrand - Paderborn University, Germany Thiago Copetti - RWTH Aachen Univ., Germany Xiaoqing Wen - Kyushu Inst. of Technology, Japan